

1A LOW NOISE CMOS LDO REGULATOR WITH ENABLE AP2114

Pin Configuration

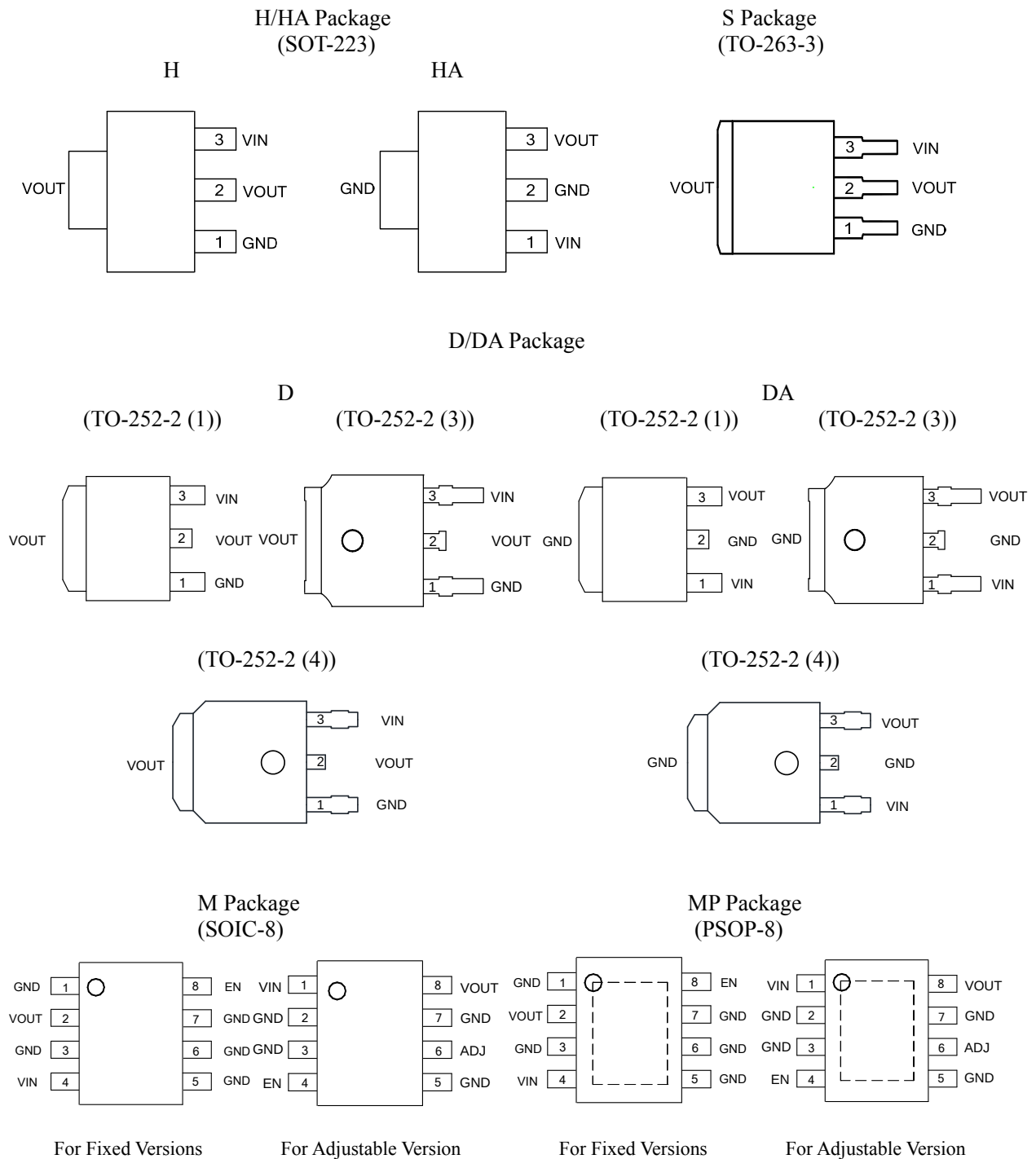
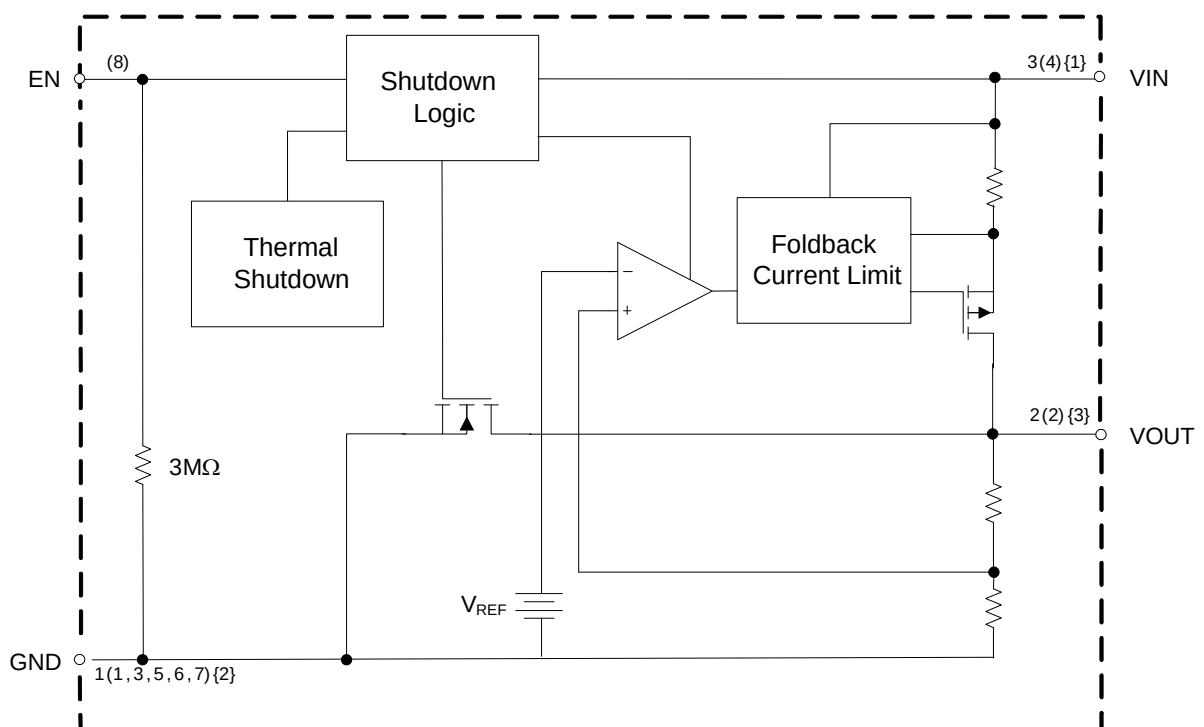


Figure 2. Pin Configuration of AP2114 (Top View)

**1A LOW NOISE CMOS LDO REGULATOR WITH ENABLE AP2114****Pin Descriptions**

Pin Number				Pin Name	Function
SOT-223 (H), TO-263-3, TO-252-2 (1) (D) TO-252-2 (3) (D) TO-252-2 (4) (D)	SOT-223 (HA), TO-252-2 (1) (DA) TO-252-2 (3) (DA) TO-252-2 (4) (DA)	SOIC-8, PSOP-8 (Fixed)	SOIC-8, PSOP-8 (ADJ)		
1	2	1, 3, 5, 6, 7	2, 3, 5, 7	GND	Ground
2	3	2	8	VOUT	Regulated Output
3	1	4	1	VIN	Input Voltage Pin
		8	4	EN	Chip Enable, H–Normal Work, L– Shutdown Output
			6	ADJ	Adjust Output

Functional Block Diagram

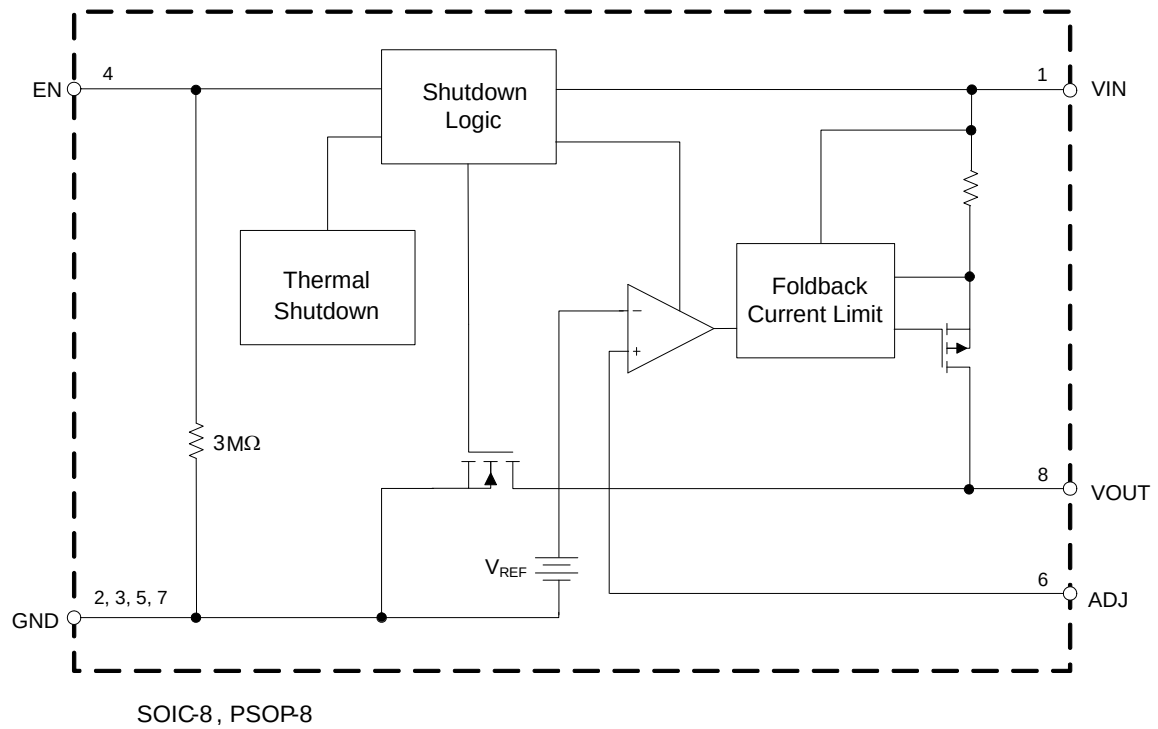
A(B){C}

A: SOT-223(H) , TO-263-3, TO-252-2 (1)/(3)/(4)(D)

B: SOIC-8, PSOP-8

C: SOT-223 (HA), TO-252-2 (1)/(3)/(4)(DA)

For Fixed Versions

1A LOW NOISE CMOS LDO REGULATOR WITH ENABLE AP2114**Functional Block Diagram (Continued)**

For ADJ Version

Figure 3. Functional Block Diagram of AP2114

**1A LOW NOISE CMOS LDO REGULATOR WITH ENABLE AP2114****Ordering Information**

Circuit Type	AP2114	□	-	□	□	□
Package						
H/HA: SOT-223						
D/DA: TO-252-2 (1)/(3)/(4)						
S: TO-263-3						
M: SOIC-8						
MP: PSOP-8						
						G1: Green
						Blank: Tube
						TR: Tape & Reel
						1.2: Fixed Output 1.2V
						1.5: Fixed Output 1.5V
						1.8: Fixed Output 1.8V
						2.5: Fixed Output 2.5V
						3.3: Fixed Output 3.3V
						ADJ: ADJ Output

Package	Temperature Range	Output Voltage	Part Number	Marking ID	Packing Type
SOT-223	-40 to 85°C	1.2V (H)	AP2114H-1.2TRG1	GH12C	Tape & Reel
		1.5V (H)	AP2114H-1.5TRG1	GH16G	Tape & Reel
		1.8V (H)	AP2114H-1.8TRG1	GH12D	Tape & Reel
		2.5V (H)	AP2114H-2.5TRG1	GH14C	Tape & Reel
		3.3V (H)	AP2114H-3.3TRG1	GH12E	Tape & Reel
SOT-223	-40 to 85°C	1.2V (HA)	AP2114HA-1.2TRG1	GH13B	Tape & Reel
		1.5V (HA)	AP2114HA-1.5TRG1	GH16H	Tape & Reel
		1.8V (HA)	AP2114HA-1.8TRG1	GH14D	Tape & Reel
		2.5V (HA)	AP2114HA-2.5TRG1	GH14E	Tape & Reel
		3.3V (HA)	AP2114HA-3.3TRG1	GH14F	Tape & Reel
TO-252-2 (1)/ TO-252-2 (3)/ TO-252-2 (4)	-40 to 85°C	1.2V (D)	AP2114D-1.2TRG1	AP2114D-1.2G1	Tape & Reel
		1.5V (D)	AP2114D-1.5TRG1	AP2114D-1.5G1	Tape & Reel
		1.8V (D)	AP2114D-1.8TRG1	AP2114D-1.8G1	Tape & Reel
		2.5V (D)	AP2114D-2.5TRG1	AP2114D-2.5G1	Tape & Reel
		3.3V (D)	AP2114D-3.3TRG1	AP2114D-3.3G1	Tape & Reel
TO-252-2 (1)/ TO-252-2 (3)/ TO-252-2 (4)	-40 to 85°C	1.2V (DA)	AP2114DA-1.2TRG1	AP2114DA-1.2G1	Tape & Reel
		1.5V (DA)	AP2114DA-1.5TRG1	AP2114DA-1.5G1	Tape & Reel
		1.8V (DA)	AP2114DA-1.8TRG1	AP2114DA-1.8G1	Tape & Reel
		2.5V (DA)	AP2114DA-2.5TRG1	AP2114DA-2.5G1	Tape & Reel
		3.3V (DA)	AP2114DA-3.3TRG1	AP2114DA-3.3G1	Tape & Reel
TO-263-3	-40 to 85°C	1.2V	AP2114S-1.2TRG1	AP2114S-1.2G1	Tape & Reel
		1.5V	AP2114S-1.5TRG1	AP2114S-1.5G1	Tape & Reel
		1.8V	AP2114S-1.8TRG1	AP2114S-1.8G1	Tape & Reel
		2.5V	AP2114S-2.5TRG1	AP2114S-2.5G1	Tape & Reel
		3.3V	AP2114S-3.3TRG1	AP2114S-3.3G1	Tape & Reel
SOIC-8	-40 to 85°C	1.2V	AP2114M-1.2TRG1	2114M-1.2G1	Tape & Reel
		1.5V	AP2114M-1.5TRG1	2114M-1.5G1	Tape & Reel
		1.8V	AP2114M-1.8TRG1	2114M-1.8G1	Tape & Reel
		2.5V	AP2114M-2.5TRG1	2114M-2.5G1	Tape & Reel
		3.3V	AP2114M-3.3TRG1	2114M-3.3G1	Tape & Reel
		ADJ	AP2114M-ADJG1	2114M-ADJG1	Tube
			AP2114M-ADJTRG1	2114M-ADJG1	Tape & Reel

**1A LOW NOISE CMOS LDO REGULATOR WITH ENABLE AP2114****Ordering Information (Continued)**

Package	Temperature Range	Output Voltage	Part Number	Marking ID	Packing Type
PSOP-8	-40 to 85°C	1.2V	AP2114MP-1.2TRG1	2114MP-1.2G1	Tape & Reel
		1.5V	AP2114MP-1.5TRG1	2114MP-1.5G1	Tape & Reel
		1.8V	AP2114MP-1.8TRG1	2114MP-1.8G1	Tape & Reel
		2.5V	AP2114MP-2.5TRG1	2114MP-2.5G1	Tape & Reel
		3.3V	AP2114MP-3.3TRG1	2114MP-3.3G1	Tape & Reel
		ADJ	AP2114MP-ADJG1	2114MP-ADJG1	Tube
			AP2114MP-ADJTRG1	2114MP-ADJG1	Tape & Reel

BCD Semiconductor's Pb-free products, as designated with "G1" suffix in the part number, are RoHS compliant and Green.

**1A LOW NOISE CMOS LDO REGULATOR WITH ENABLE AP2114****Absolute Maximum Ratings (Note 1)**

Parameter	Symbol	Value		Unit
Power Supply Voltage	V_{IN}	6.5		V
Operating Junction Temperature Range	T_J	150		°C
Storage Temperature Range	T_{STG}	-65 to 150		°C
Lead Temperature (Soldering, 10sec)	T_{LEAD}	260		°C
Thermal Resistance (Junction to Ambient) (No Heatsink)	θ_{JA}	SOIC-8	144	°C/W
		PSOP-8	143	
		SOT-223	128	
		TO-252-2 (1)/ TO-252-2 (3)/ TO-252-2 (4)	90	
		TO-263-3	73	
ESD (Machine Model)		400		V
ESD (Human Body Model)		4000		V

Note 1: Stresses greater than those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “Recommended Operating Conditions” is not implied. Exposure to “Absolute Maximum Ratings” for extended periods may affect device reliability.

Recommended Operating Conditions

Parameter	Symbol	Min	Max	Unit
Supply Voltage	V_{IN}	2.5	6.0	V
Operating Ambient Temperature Range	T_A	-40	85	°C

**1A LOW NOISE CMOS LDO REGULATOR WITH ENABLE AP2114****Electrical Characteristics****AP2114-1.2 Electrical Characteristics (Note 2)**

($V_{IN}=2.5V$, $C_{IN}=4.7\mu F$ (Ceramic), $C_{OUT}=4.7\mu F$ (Ceramic), Typical $T_A=25^\circ C$, **Bold** typeface applies over $-40^\circ C \leq T_A \leq 85^\circ C$ ranges, unless otherwise specified (Note 3))

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Output Voltage	V_{OUT}	$V_{IN}=2.5V$, $1mA \leq I_{OUT} \leq 30mA$	$V_{OUT} \times 98.5\%$	1.2	$V_{OUT} \times 101.5\%$	V
Input Voltage	V_{IN}				6.0	V
Maximum Output Current	$I_{OUT(MAX)}$	$V_{IN}=2.5V$, $V_{OUT}=1.182V$ to $1.218V$	1			A
Load Regulation	$\frac{\Delta V_{OUT}/V_{OUT}}{\Delta I_{OUT}}$	$V_{IN}=2.5V$, $1mA \leq I_{OUT} \leq 1A$		0.2	1	%/A
Line Regulation	$\frac{\Delta V_{OUT}/V_{OUT}}{\Delta V_{IN}}$	$2.5V \leq V_{IN} \leq 6V$, $I_{OUT}=30mA$	-0.1	0.02	0.1	%/V
Dropout Voltage	V_{DROP}	$I_{OUT}=1.0A$		1200	1300	mV
Quiescent Current	I_Q	$V_{IN}=2.5V$, $I_{OUT}=0mA$		60	75	μA
Power Supply Rejection Ratio	PSRR	Ripple 1Vp-p $V_{IN}=2.5V$, $I_{OUT}=100mA$	$f=100Hz$	68		dB
			$f=1KHz$	68		
Output Voltage Temperature Coefficient	$\frac{\Delta V_{OUT}/V_{OUT}}{\Delta T}$	$I_{OUT}=30mA$, $T_A=-40^\circ C$ to $85^\circ C$		± 30		ppm/ $^\circ C$
Short Current Limit	I_{SHORT}	$V_{OUT}=0V$		50		mA
RMS Output Noise	V_{NOISE}	$10Hz \leq f \leq 100kHz$ (No Load)		30		μV_{RMS}
V_{EN} High Voltage	V_{IH}	Enable logic high, regulator on	1.5			V
V_{EN} Low Voltage	V_{IL}	Enable logic low, regulator off			0.4	
Standby Current	I_{STD}	$V_{IN}=2.5V$, V_{EN} in OFF mode		0.01	1.0	μA
Start-up Time	t_s	No Load		20		μs
EN Pull Down Resistor	R_{PD}			3.0		$M\Omega$
V_{OUT} Discharge Resistor	R_{DCHG}	Set EN pin at Low		60		Ω
Thermal Shutdown Temperature	T_{OTSD}			160		$^\circ C$
Thermal Shutdown Hysteresis	T_{HYOTSD}			25		
Thermal Resistance (Junction to Case)	θ_{JC}	SOIC-8		74.6		$^\circ C/W$
		PSOP-8		43.7		
		SOT-223		50.9		
		TO-252-2 (1)/(3)/(4)		35		
		TO-263-3		22		

Note 2: To prevent the Short Circuit Current protection feature from being prematurely activated, the input voltage must be applied before a current source load is applied.

Note 3: Production testing at $T_A=25^\circ C$. Over temperature specifications guaranteed by design only.

**1A LOW NOISE CMOS LDO REGULATOR WITH ENABLE AP2114****Electrical Characteristics (Continued)****AP2114-1.5 Electrical Characteristics (Note 2)**

($V_{IN}=2.5V$, $C_{IN}=4.7\mu F$ (Ceramic), $C_{OUT}=4.7\mu F$ (Ceramic), Typical $T_A=25^\circ C$, **Bold** typeface applies over $-40^\circ C \leq T_A \leq 85^\circ C$ ranges, unless otherwise specified (Note 3))

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Output Voltage	V_{OUT}	$V_{IN}=2.5V$, $1mA \leq I_{OUT} \leq 30mA$	$V_{OUT} \times 98.5\%$	1.5	$V_{OUT} \times 101.5\%$	V
Input Voltage	V_{IN}				6.0	V
Maximum Output Current	$I_{OUT(MAX)}$	$V_{IN}=2.5V$, $V_{OUT}=1.478V$ to $1.523V$	1			A
Load Regulation	$\frac{\Delta V_{OUT}/V_{OUT}}{\Delta I_{OUT}}$	$V_{IN}=2.5V$, $1mA \leq I_{OUT} \leq 1A$		0.2	1	%/A
Line Regulation	$\frac{\Delta V_{OUT}/V_{OUT}}{\Delta V_{IN}}$	$2.5V \leq V_{IN} \leq 6V$, $I_{OUT}=30mA$	-0.1	0.02	0.1	%/V
Dropout Voltage	V_{DROP}	$I_{OUT}=1.0A$		800	1000	mV
Quiescent Current	I_Q	$V_{IN}=2.5V$, $I_{OUT}=0mA$		60	75	μA
Power Supply Rejection Ratio	PSRR	Ripple 1Vp-p $V_{IN}=2.5V$, $I_{OUT}=100mA$ f=100Hz		68		dB
		f=1KHz		68		
Output Voltage Temperature Coefficient	$\frac{\Delta V_{OUT}/V_{OUT}}{\Delta T}$	$I_{OUT}=30mA$, $T_A=-40^\circ C$ to $85^\circ C$		± 30		ppm/ $^\circ C$
Short Current Limit	I_{SHORT}	$V_{OUT}=0V$		50		mA
RMS Output Noise	V_{NOISE}	$10Hz \leq f \leq 100kHz$ (No Load)		30		μV_{RMS}
V_{EN} High Voltage	V_{IH}	Enable logic high, regulator on	1.5			V
V_{EN} Low Voltage	V_{IL}	Enable logic low, regulator off			0.4	
Standby Current	I_{STD}	$V_{IN}=2.5V$, V_{EN} in OFF mode		0.01	1.0	μA
Start-up Time	t_s	No Load		20		μs
EN Pull Down Resistor	R_{PD}			3.0		M Ω
V_{OUT} Discharge Resistor	R_{DCHG}	Set EN pin at Low		60		Ω
Thermal Shutdown Temperature	T_{OTSD}			160		$^\circ C$
Thermal Shutdown Hysteresis	T_{HYOTSD}			25		
Thermal Resistance (Junction to Case)	θ_{JC}	SOIC-8		74.6		$^\circ C/W$
		PSOP-8		43.7		
		SOT-223		50.9		
		TO-252-2 (1)/(3)/(4)		35		
		TO-263-3		22		

Note 2: To prevent the Short Circuit Current protection feature from being prematurely activated, the input voltage must be applied before a current source load is applied.

Note 3: Production testing at $T_A=25^\circ C$. Over temperature specifications guaranteed by design only.

**1A LOW NOISE CMOS LDO REGULATOR WITH ENABLE AP2114****Electrical Characteristics (Continued)****AP2114-1.8 Electrical Characteristics (Note 2)**

($V_{IN}=2.8V$, $C_{IN}=4.7\mu F$ (Ceramic), $C_{OUT}=4.7\mu F$ (Ceramic), Typical $T_A=25^\circ C$, **Bold** typeface applies over $-40^\circ C \leq T_A \leq 85^\circ C$ ranges, unless otherwise specified (Note 3))

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Output Voltage	V_{OUT}	$V_{IN}=2.8V$, $1mA \leq I_{OUT} \leq 30mA$	$V_{OUT} \times 98.5\%$	1.8	$V_{OUT} \times 101.5\%$	V
Maximum Output Current	$I_{OUT(MAX)}$	$V_{IN}=2.8V$, $V_{OUT}=1.773V$ to $1.827V$	1.0			A
Load Regulation	$\frac{\Delta V_{OUT}/V_{OUT}}{\Delta I_{OUT}}$	$V_{IN}=2.8V$, $1mA \leq I_{OUT} \leq 1A$		0.2	1.0	%/A
Line Regulation	$\frac{\Delta V_{OUT}/V_{OUT}}{\Delta V_{IN}}$	$2.8V \leq V_{IN} \leq 6V$, $I_{OUT}=30mA$	-0.1	0.02	0.1	%/V
Dropout Voltage	V_{DROP}	$I_{OUT}=1.0A$		500	700	mV
Quiescent Current	I_Q	$V_{IN}=2.8V$, $I_{OUT}=0mA$		60	75	μA
Power Supply Rejection Ratio	PSRR	Ripple 1Vp-p $V_{IN}=2.8V$, $I_{OUT}=100mA$	$f=100Hz$	68		dB
			$f=1KHz$	68		
Output Voltage Temperature Coefficient	$\frac{\Delta V_{OUT}/V_{OUT}}{\Delta T}$	$I_{OUT}=30mA$, $T_A=-40^\circ C$ to $85^\circ C$		± 30		ppm/ $^\circ C$
Short Current Limit	I_{SHORT}	$V_{OUT}=0V$		50		mA
RMS Output Noise	V_{NOISE}	$10Hz \leq f \leq 100kHz$ (No load)		30		μV_{RMS}
V_{EN} High Voltage	V_{IH}	Enable logic high, regulator on	1.5			V
V_{EN} Low Voltage	V_{IL}	Enable logic low, regulator off			0.4	
Standby Current	I_{STD}	$V_{IN}=2.8V$, V_{EN} in OFF mode		0.01	1.0	μA
Start-up Time	t_S	No Load		20		μs
EN Pull Down Resistor	R_{PD}			3.0		$M\Omega$
V_{OUT} Discharge Resistor	R_{DCHG}	Set EN pin at Low		60		Ω
Thermal Shutdown Temperature	T_{OTSD}			160		$^\circ C$
Thermal Shutdown Hysteresis	T_{HYOTSD}			25		
Thermal Resistance (Junction to Case)	θ_{JC}	SOIC-8		74.6		$^\circ C/W$
		PSOP-8		43.7		
		SOT-223		50.9		
		TO-252-2 (1)/(3)/(4)		35		
		TO-263-3		22		

Note 2: To prevent the Short Circuit Current protection feature from being prematurely activated, the input voltage must be applied before a current source load is applied.

Note 3: Production testing at $T_A=25^\circ C$. Over temperature specifications guaranteed by design only.

**1A LOW NOISE CMOS LDO REGULATOR WITH ENABLE AP2114****Electrical Characteristics (Continued)****AP2114-2.5 Electrical Characteristics (Note 2)**

($V_{IN}=3.5V$, $C_{IN}=4.7\mu F$ (Ceramic), $C_{OUT}=4.7\mu F$ (Ceramic), Typical $T_A=25^\circ C$, **Bold** typeface applies over $-40^\circ C \leq T_A \leq 85^\circ C$ ranges, unless otherwise specified (Note 3))

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Output Voltage	V_{OUT}	$V_{IN}=3.5V$, $1mA \leq I_{OUT} \leq 30mA$	$V_{OUT} \times 98.5\%$	2.5	$V_{OUT} \times 101.5\%$	V
Maximum Output Current	$I_{OUT(MAX)}$	$V_{IN}=3.5V$, $V_{OUT}=2.463V$ to $2.537V$	1.0			A
Load Regulation	$\frac{\Delta V_{OUT}/V_{OUT}}{\Delta I_{OUT}}$	$V_{OUT}=2.5V$, $V_{IN}=V_{OUT}+1V$ $1mA \leq I_{OUT} \leq 1A$		0.2	1.0	%/A
Line Regulation	$\frac{\Delta V_{OUT}/V_{OUT}}{\Delta V_{IN}}$	$3.5V \leq V_{IN} \leq 6V$, $I_{OUT}=30mA$	-0.1	0.02	0.1	%/V
Dropout Voltage	V_{DROP}	$I_{OUT}=1A$		450	750	mV
Quiescent Current	I_Q	$V_{IN}=3.5V$, $I_{OUT}=0mA$		60	80	μA
Power Supply Rejection Ratio	PSRR	Ripple 1Vp-p $V_{IN}=3.5V$, $I_{OUT}=100mA$	$f=100Hz$	65		dB
			$f=1KHz$	65		
Output Voltage Temperature Coefficient	$\frac{\Delta V_{OUT}/V_{OUT}}{\Delta T}$	$I_{OUT}=30mA$		± 30		ppm/ $^\circ C$
Short Current Limit	I_{SHORT}	$V_{OUT}=0V$		50		mA
RMS Output Noise	V_{NOISE}	$10Hz \leq f \leq 100kHz$		30		μV_{RMS}
V_{EN} High Voltage	V_{IH}	Enable logic high, regulator on	1.5			V
V_{EN} Low Voltage	V_{IL}	Enable logic low, regulator off			0.4	
Standby Current	I_{STD}	$V_{IN}=3.5V$, V_{EN} in OFF mode		0.01	1.0	μA
Start-up Time	t_s	No Load		20		μs
EN Pull Down Resistor	R_{PD}			3.0		$M\Omega$
V_{OUT} Discharge Resistor	R_{DCHG}	Set EN pin at Low		60		Ω
Thermal Shutdown Temperature	T_{OTSD}			160		$^\circ C$
Thermal Shutdown Hysteresis	T_{HYOTSD}			25		
Thermal Resistance (Junction to Case)	θ_{JC}	SOIC-8		74.6		$^\circ C/W$
		PSOP-8		43.7		
		SOT-223		50.9		
		TO-252-2 (1)/(3)/(4)		35		
		TO-263-3		22		

Note 2: To prevent the Short Circuit Current protection feature from being prematurely activated, the input voltage must be applied before a current source load is applied.

Note 3: Production testing at $T_A=25^\circ C$. Over temperature specifications guaranteed by design only.

**1A LOW NOISE CMOS LDO REGULATOR WITH ENABLE AP2114****Electrical Characteristics (Continued)****AP2114-3.3 Electrical Characteristics (Note 2)**

($V_{IN}=4.3V$, $C_{IN}=4.7\mu F$ (Ceramic), $C_{OUT}=4.7\mu F$ (Ceramic), Typical $T_A=25^\circ C$, **Bold** typeface applies over $-40^\circ C \leq T_A \leq 85^\circ C$ ranges, unless otherwise specified (Note 3))

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Output Voltage	V_{OUT}	$V_{IN}=4.3V$, $1mA \leq I_{OUT} \leq 30mA$	$V_{OUT} \times 98.5\%$	3.3	$V_{OUT} \times 101.5\%$	V
Maximum Output Current	$I_{OUT(MAX)}$	$V_{IN}=4.3V$, $V_{OUT}=3.25V$ to $3.35V$	1.0			A
Load Regulation	$\frac{\Delta V_{OUT}/V_{OUT}}{\Delta I_{OUT}}$	$V_{IN}=4.3V$, $1mA \leq I_{OUT} \leq 1A$		0.2	1.0	%/A
Line Regulation	$\frac{\Delta V_{OUT}/V_{OUT}}{\Delta V_{IN}}$	$4.3V \leq V_{IN} \leq 6V$, $I_{OUT}=30mA$	-0.1	0.02	0.1	%/V
Dropout Voltage	V_{DROP}	$I_{OUT}=1A$		450	750	mV
Quiescent Current	I_Q	$V_{IN}=4.3V$, $I_{OUT}=0mA$		65	90	μA
Power Supply Rejection Ratio	PSRR	Ripple 1Vp-p $V_{IN}=4.3V$, $I_{OUT}=100mA$	f=100Hz	65		dB
			f=1KHz	65		
Output Voltage Temperature Coefficient	$\frac{\Delta V_{OUT}/V_{OUT}}{\Delta T}$	$I_{OUT}=30mA$		± 30		ppm/ $^\circ C$
Short Current Limit	I_{SHORT}	$V_{OUT}=0V$		50		mA
RMS Output Noise	V_{NOISE}	$10Hz \leq f \leq 100kHz$ (No load)		30		μV_{RMS}
V_{EN} High Voltage	V_{IH}	Enable logic high, regulator on	1.5			V
V_{EN} Low Voltage	V_{IL}	Enable logic low, regulator off			0.4	
Standby Current	I_{STD}	$V_{IN}=4.3V$, V_{EN} in OFF mode		0.01	1.0	μA
Start-up Time	t_S	No Load		20		μs
EN Pull Down Resistor	R_{PD}			3.0		M Ω
V_{OUT} Discharge Resistor	R_{DCHG}	Set EN pin at Low		60		Ω
Thermal Shutdown Temperature	T_{OTSD}			160		$^\circ C$
Thermal Shutdown Hysteresis	T_{HYOTSD}			25		
Thermal Resistance (Junction to Case)	θ_{JC}	SOIC-8		74.6		$^\circ C/W$
		PSOP-8		43.7		
		SOT-223		50.9		
		TO-252-2 (1)/(3)/(4)		35		
		TO-263-3		22		

Note 2: To prevent the Short Circuit Current protection feature from being prematurely activated, the input voltage must be applied before a current source load is applied.

Note 3: Production testing at $T_A=25^\circ C$. Over temperature specifications guaranteed by design only.

**1A LOW NOISE CMOS LDO REGULATOR WITH ENABLE AP2114****Electrical Characteristics (Continued)****AP2114-ADJ Electrical Characteristics (Note 2)**

($V_{IN}=2.5V$, $C_{IN}=4.7\mu F$ (Ceramic), $C_{OUT}=4.7\mu F$ (Ceramic), Typical $T_A=25^\circ C$, **Bold** typeface applies over $-40^\circ C \leq T_A \leq 85^\circ C$ ranges, unless otherwise specified (Note 3))

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Reference Voltage	V_{REF}	$V_{IN}=2.5V$, $1mA \leq I_{OUT} \leq 30mA$	$V_{REF} \times 98.5\%$	0.8	$V_{REF} \times 101.5\%$	V
Input Voltage	V_{IN}				6.0	V
Maximum Output Current	$I_{OUT(MAX)}$	$V_{IN}=2.5V$, $V_{OUT}=0.788V$ to $0.812V$	1			A
Load Regulation	$\frac{\Delta V_{OUT}/V_{OUT}}{\Delta I_{OUT}}$	$V_{IN}=2.5V$, $1mA \leq I_{OUT} \leq 1A$		0.2	1	%/A
Line Regulation	$\frac{\Delta V_{OUT}/V_{OUT}}{\Delta V_{IN}}$	$2.5V \leq V_{IN} \leq 6V$, $I_{OUT}=30mA$	-0.1	0.02	0.1	%/V
Quiescent Current	I_Q	$V_{IN}=2.5V$, $I_{OUT}=0mA$		60	75	μA
Power Supply Rejection Ratio	PSRR	Ripple 1Vp-p $V_{IN}=2.5V$, $I_{OUT}=100mA$ $f=100Hz$		68		dB
		$f=1KHz$		68		
Output Voltage Temperature Coefficient	$\frac{\Delta V_{OUT}/V_{OUT}}{\Delta T}$	$I_{OUT}=30mA$, $T_A=-40^\circ C$ to $85^\circ C$		± 30		ppm/ $^\circ C$
Short Current Limit	I_{SHORT}	$V_{OUT}=0V$		50		mA
RMS Output Noise	V_{NOISE}	$10Hz \leq f \leq 100kHz$ (No Load)		30		μV_{RMS}
V_{EN} High Voltage	V_{IH}	Enable logic high, regulator on	1.5			V
V_{EN} Low Voltage	V_{IL}	Enable logic low, regulator off			0.4	
Standby Current	I_{STD}	$V_{IN}=2.5V$, V_{EN} in OFF mode		0.01	1.0	μA
Start-up Time	t_s	No Load		20		μs
EN Pull Down Resistor	R_{PD}			3.0		M Ω
V_{OUT} Discharge Resistor	R_{DCHG}	Set EN pin at Low		60		Ω
Thermal Shutdown Temperature	T_{OTSD}			160		$^\circ C$
Thermal Shutdown Hysteresis	T_{HYOTSD}			25		
Thermal Resistance (Junction to Case)	θ_{JC}	SOIC-8		74.6		$^\circ C/W$
		PSOP-8		43.7		

Note 2: To prevent the Short Circuit Current protection feature from being prematurely activated, the input voltage must be applied before a current source load is applied.

Note 3: Production testing at $T_A=25^\circ C$. Over temperature specifications guaranteed by design only.

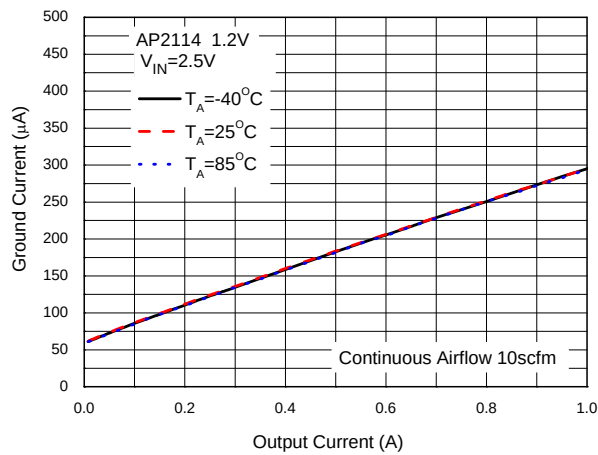
**1A LOW NOISE CMOS LDO REGULATOR WITH ENABLE AP2114****Typical Performance Characteristics**

Figure 4. Ground Current vs. Output Current

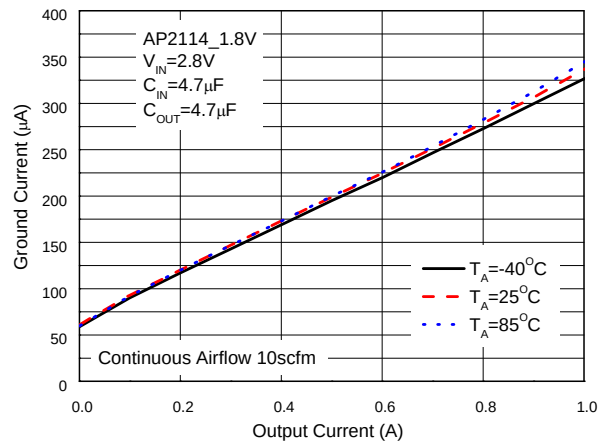


Figure 5. Ground Current vs. Output Current

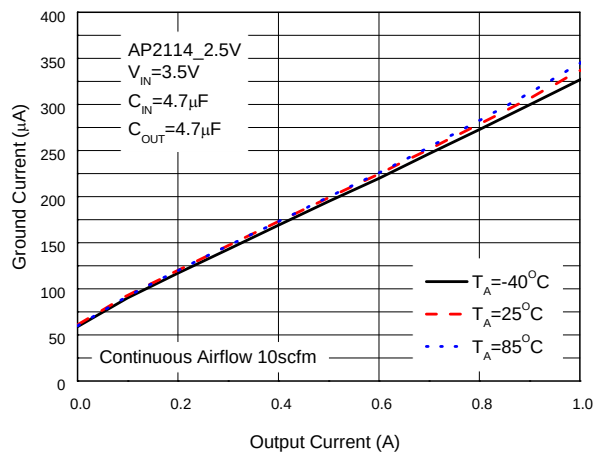


Figure 6. Ground Current vs. Output Current

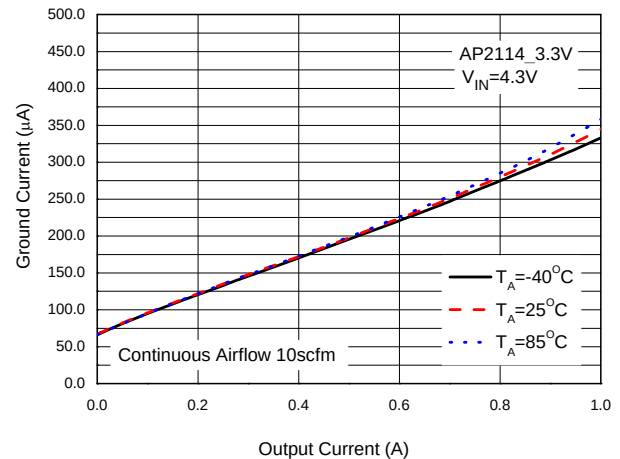


Figure 7. Ground Current vs. Output Current

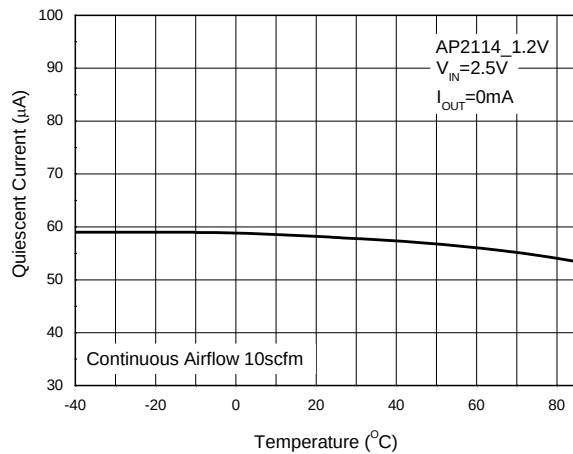
1A LOW NOISE CMOS LDO REGULATOR WITH ENABLE AP2114**Typical Performance Characteristics (Continued)**

Figure 8. Quiescent Current vs. Temperature

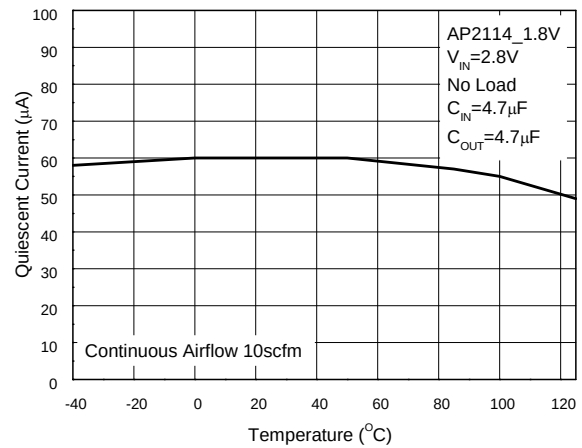


Figure 9. Quiescent Current vs. Temperature

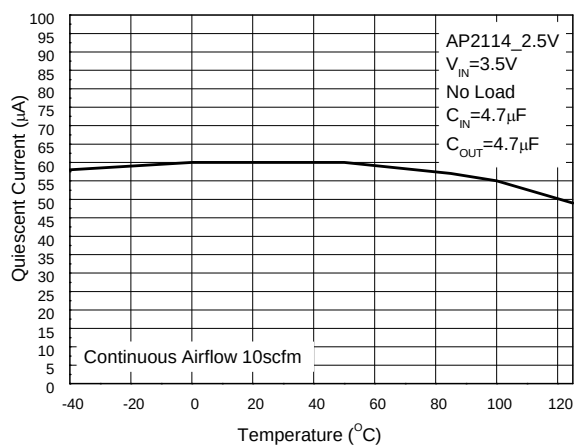


Figure 10. Quiescent Current vs. Temperature

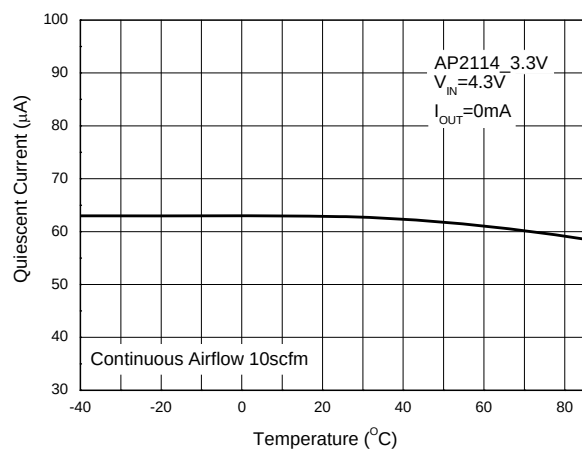


Figure 11. Quiescent Current vs. Temperature

1A LOW NOISE CMOS LDO REGULATOR WITH ENABLE AP2114

Typical Performance Characteristics (Continued)

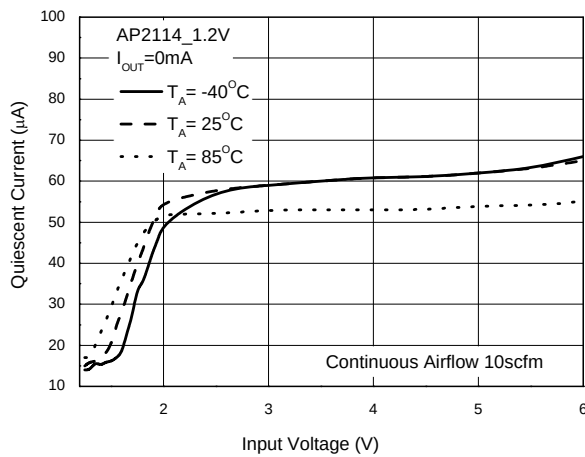


Figure 12. Quiescent Current vs. Input Voltage

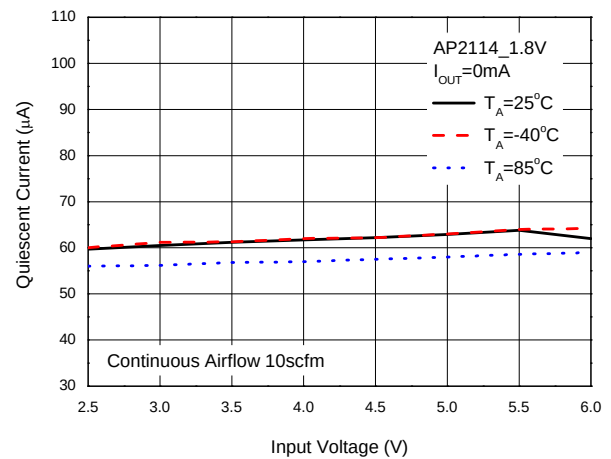


Figure 13. Quiescent Current vs. Input Voltage

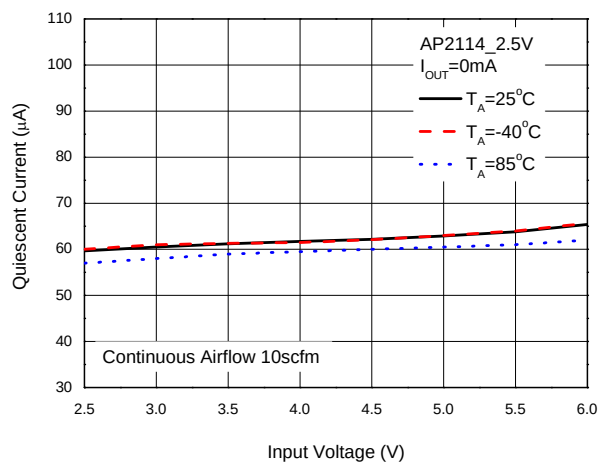


Figure 14. Quiescent Current vs. Input Voltage

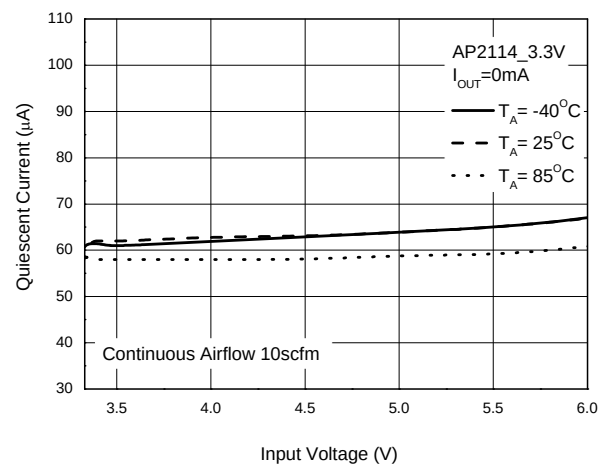


Figure 15. Quiescent Current vs. Input Voltage

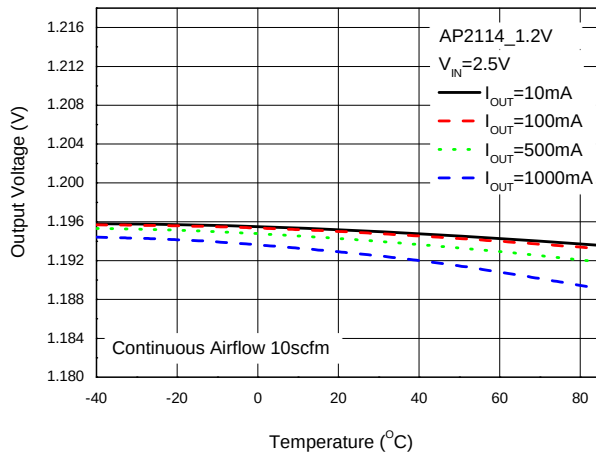
1A LOW NOISE CMOS LDO REGULATOR WITH ENABLE AP2114**Typical Performance Characteristics (Continued)**

Figure 16. Output Voltage vs. Temperature

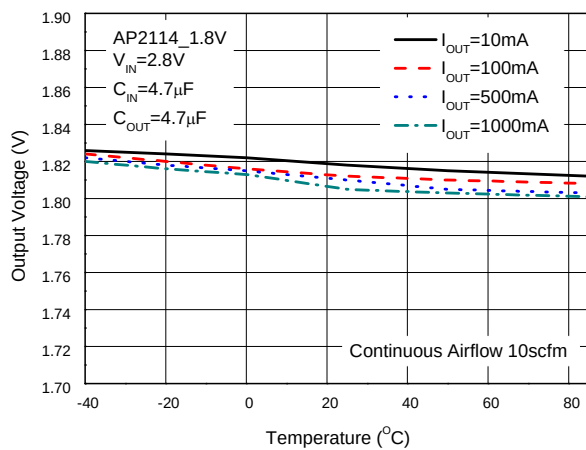


Figure 17. Output Voltage vs. Temperature

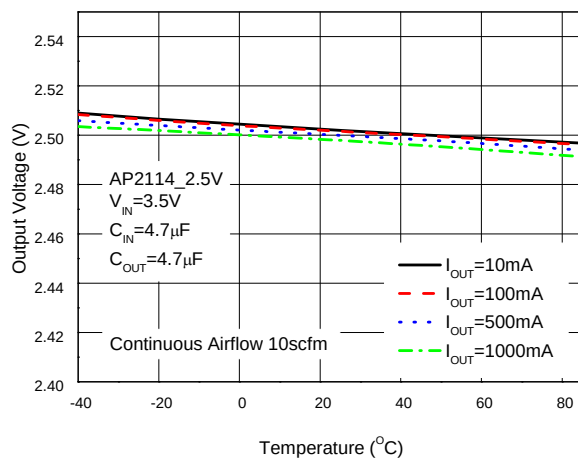


Figure 18. Output Voltage vs. Temperature

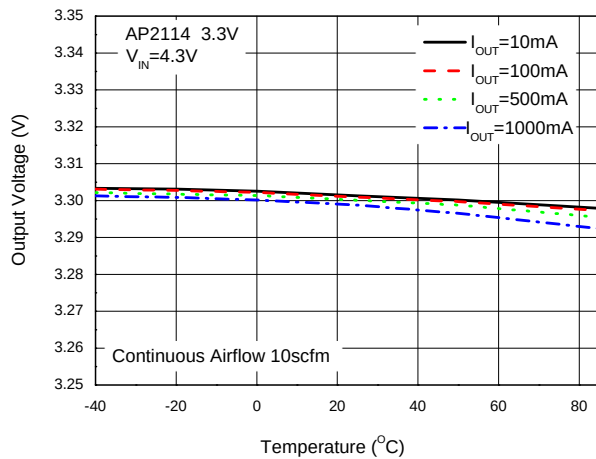


Figure 19. Output Voltage vs. Temperature

1A LOW NOISE CMOS LDO REGULATOR WITH ENABLE AP2114

Typical Performance Characteristics (Continued)

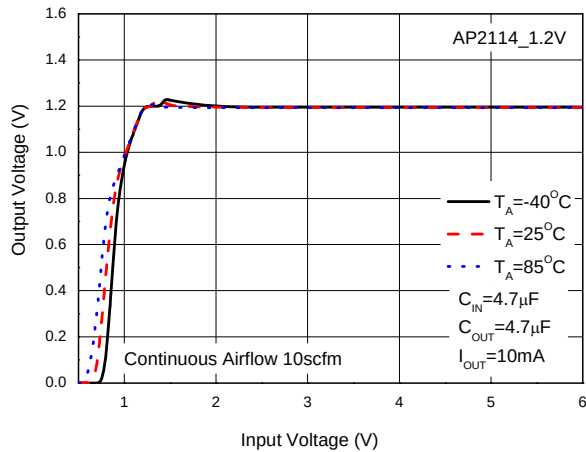


Figure 20. Output Voltage vs. Input Voltage

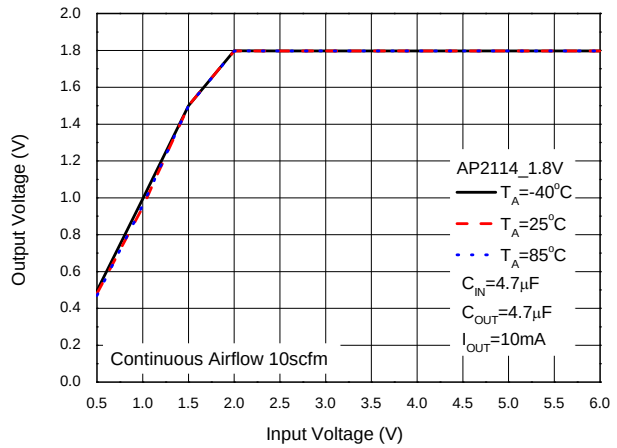


Figure 21. Output Voltage vs. Input Voltage

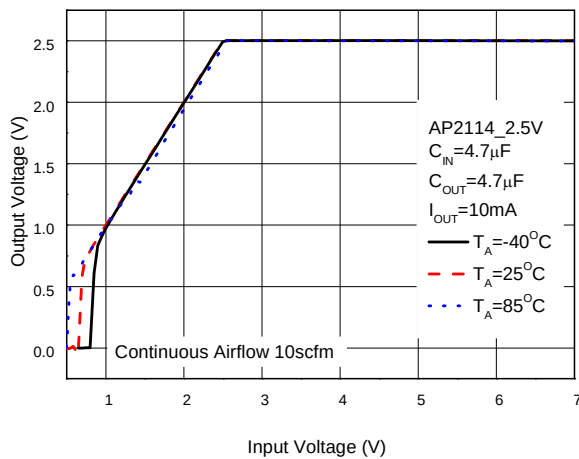


Figure 22. Output Voltage vs. Input Voltage

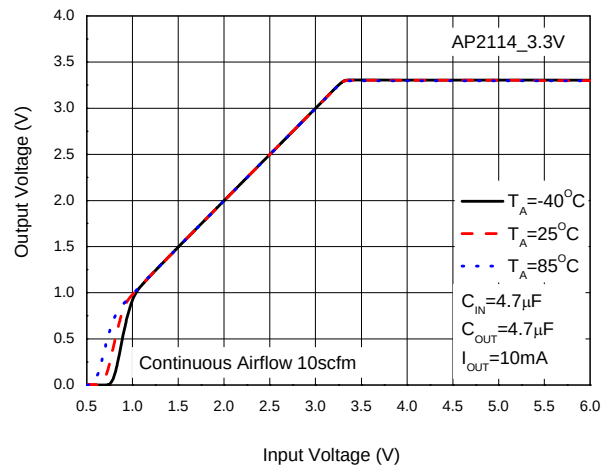


Figure 23. Output Voltage vs. Input Voltage

1A LOW NOISE CMOS LDO REGULATOR WITH ENABLE AP2114

Typical Performance Characteristics (Continued)

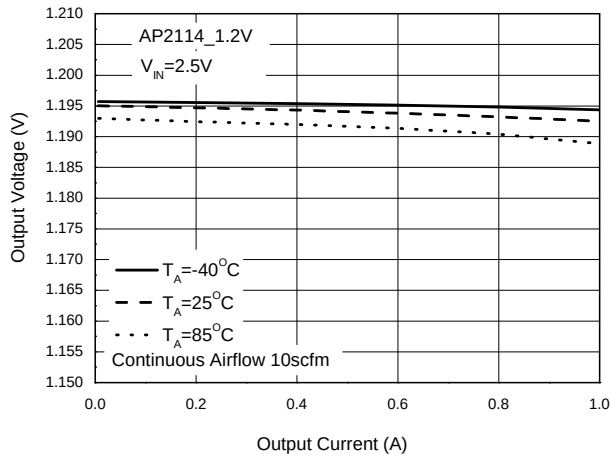


Figure 24. Output Voltage vs. Output Current

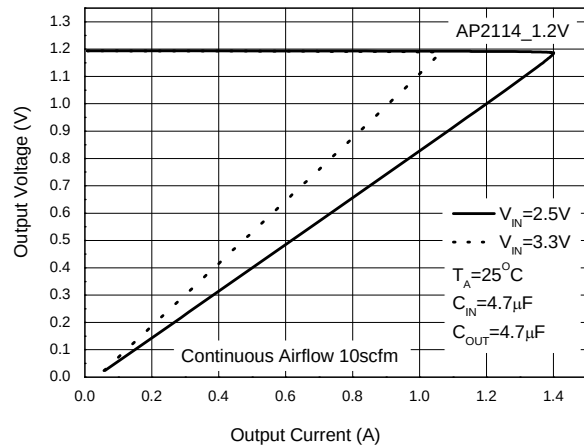


Figure 25. Output Voltage vs. Output Current

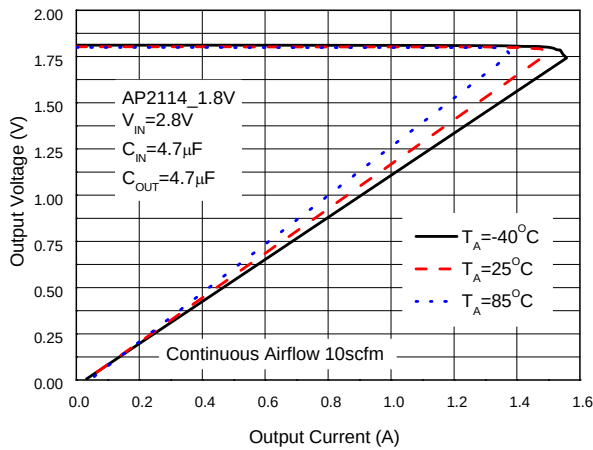


Figure 26. Output Voltage vs. Output Current

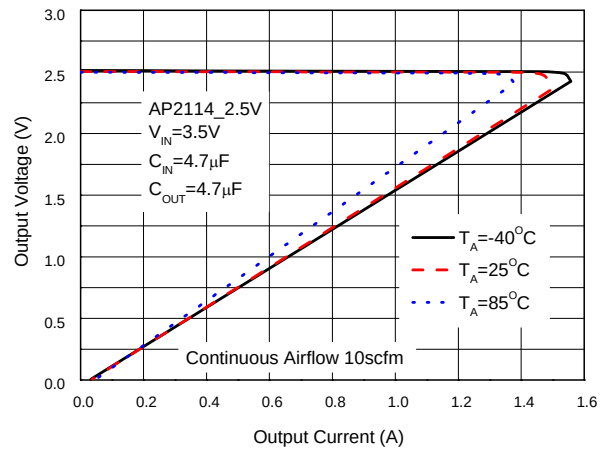


Figure 27. Output Voltage vs. Output Current

1A LOW NOISE CMOS LDO REGULATOR WITH ENABLE AP2114

Typical Performance Characteristics (Continued)

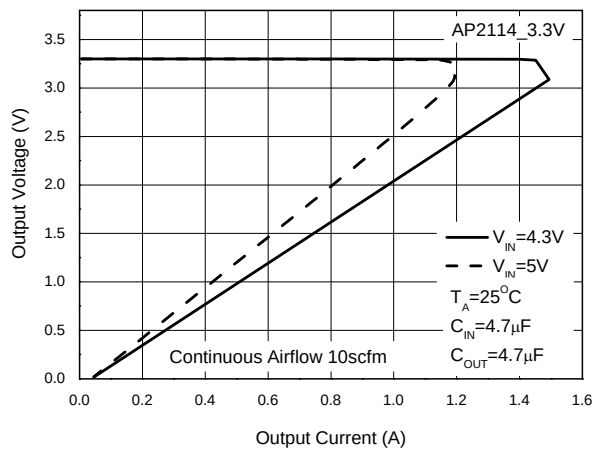


Figure 28. Output Voltage vs. Output Current

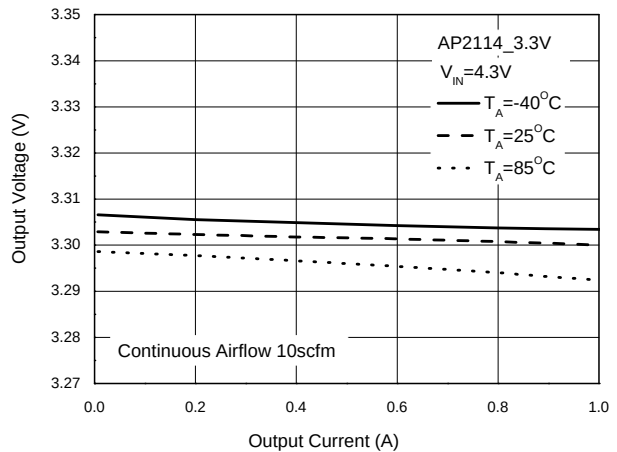


Figure 29. Output Voltage vs. Output Current

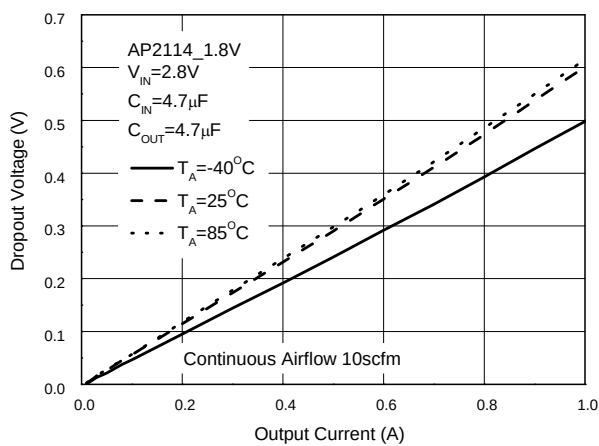


Figure 30. Dropout Voltage vs. Output Current

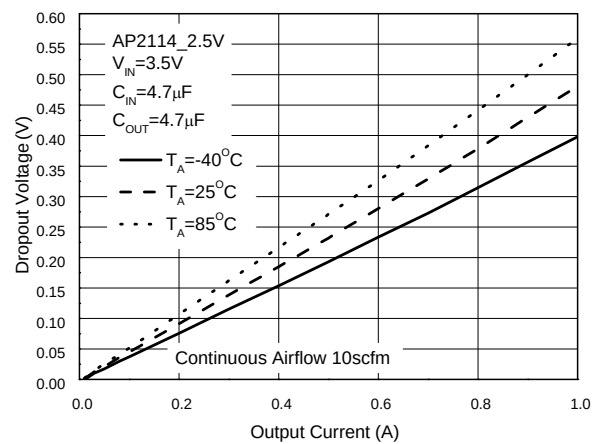


Figure 31. Dropout Voltage vs. Output Current

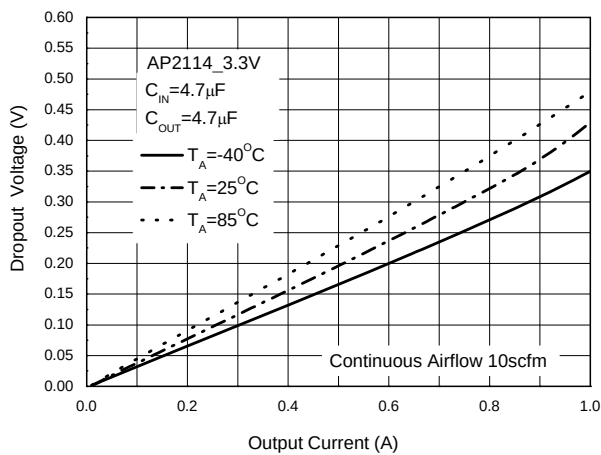
1A LOW NOISE CMOS LDO REGULATOR WITH ENABLE AP2114**Typical Performance Characteristics (Continued)**

Figure 32. Dropout Voltage vs. Output Current

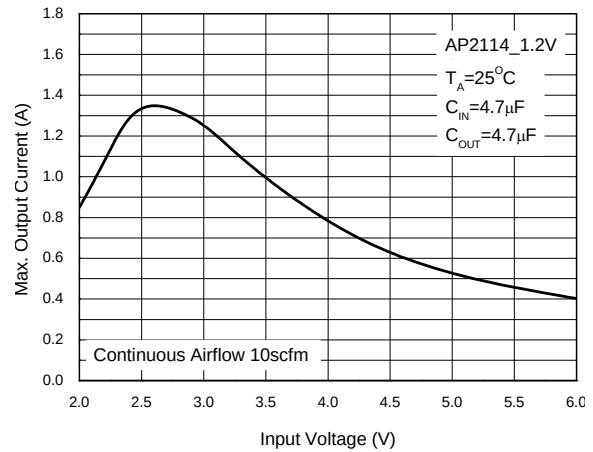


Figure 33. Max. Output Current vs. Input Voltage

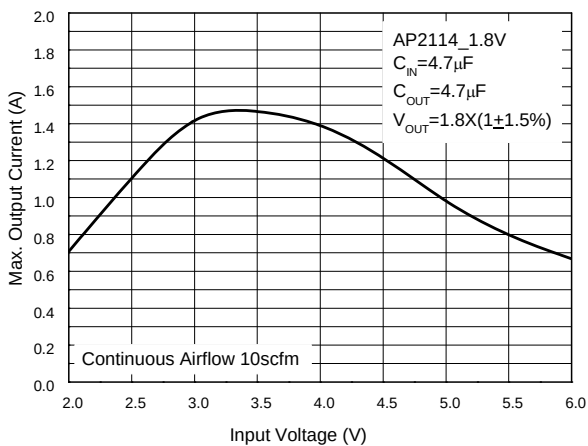


Figure 34. Max. Output Current vs. Input Voltage

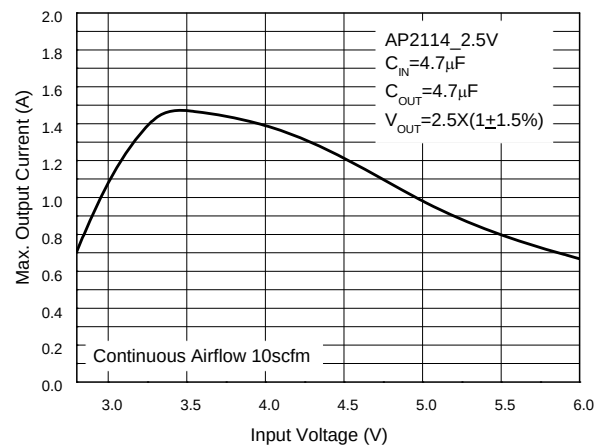


Figure 35. Max. Output Current vs. Input Voltage

1A LOW NOISE CMOS LDO REGULATOR WITH ENABLE AP2114

Typical Performance Characteristics (Continued)

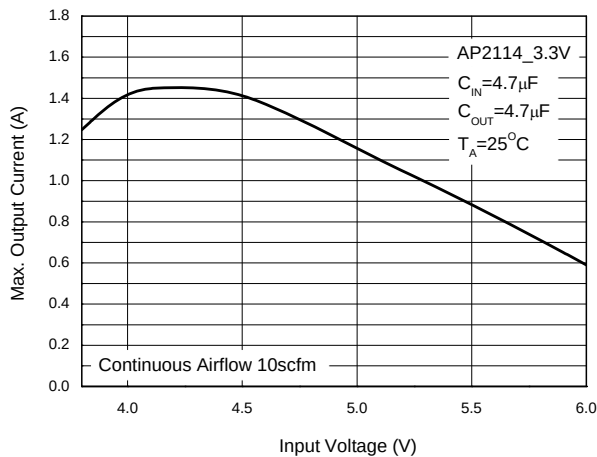


Figure 36. Max. Output Current vs. Input Voltage

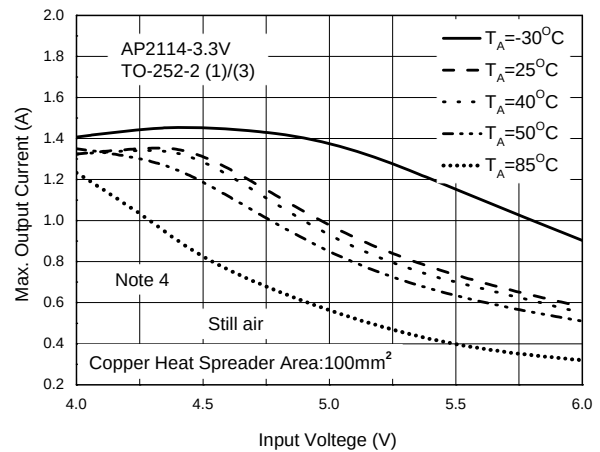


Figure 37. Max. Output Current vs. Input Voltage

Note 4: Considering power dissipation and thermal behavior, we suggest provide enough design margins in application design which are no less than 30% at least.

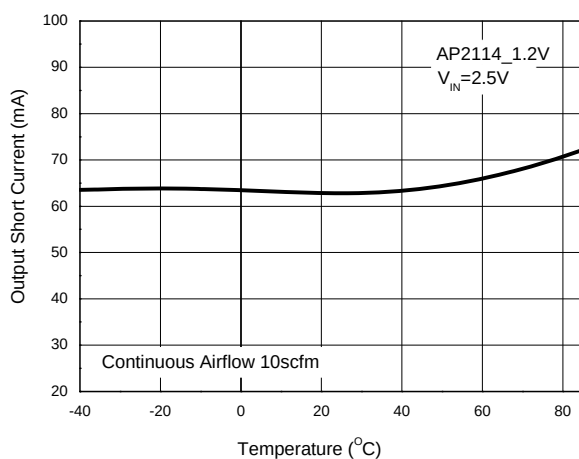


Figure 38. Output Short Current vs. Temperature

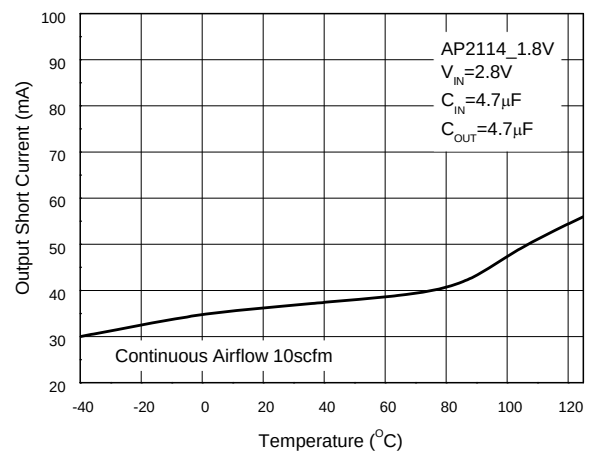


Figure 39. Output Short Current vs. Temperature

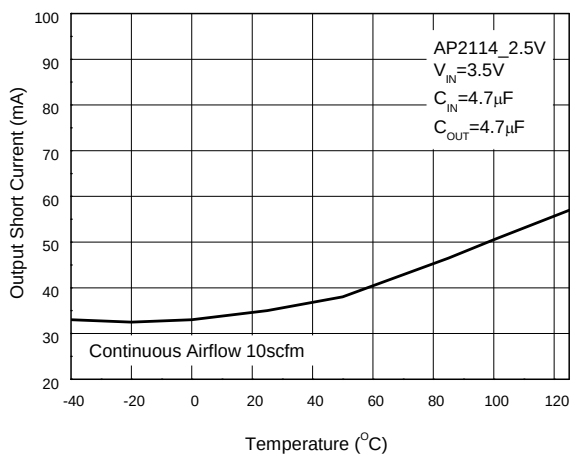
1A LOW NOISE CMOS LDO REGULATOR WITH ENABLE AP2114**Typical Performance Characteristics (Continued)**

Figure 40. Output Short Current vs. Temperature

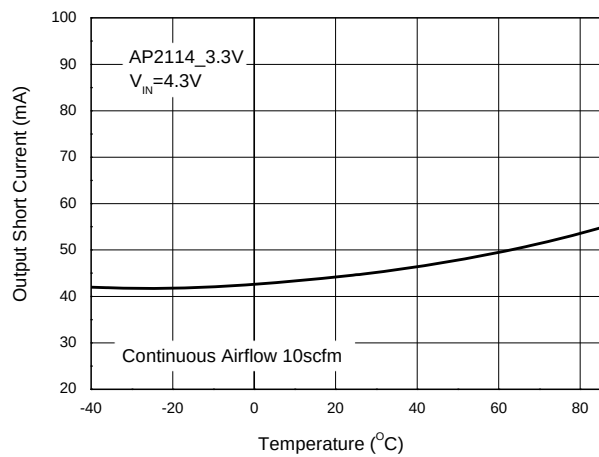


Figure 41. Output Short Current vs. Temperature

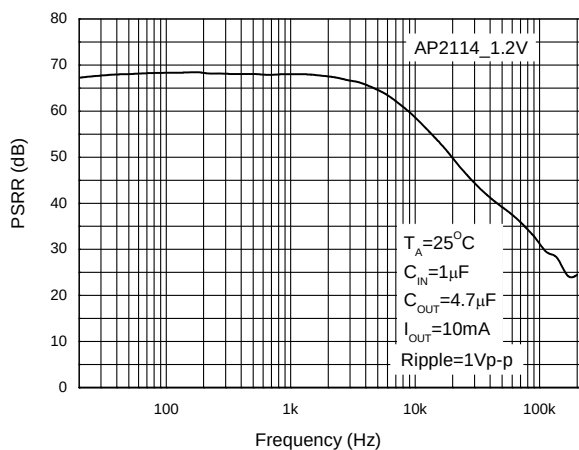


Figure 42. PSRR vs. Frequency

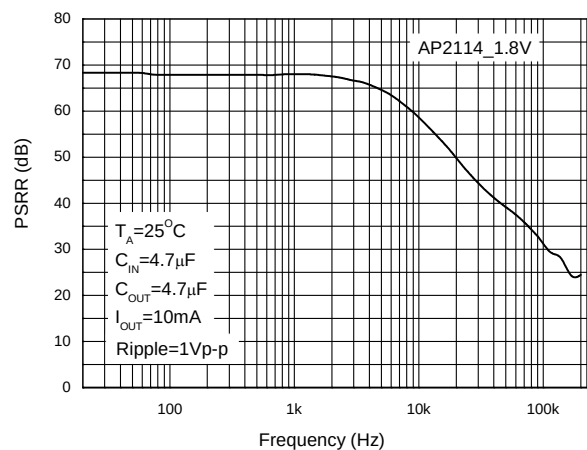


Figure 43. PSRR vs. Frequency

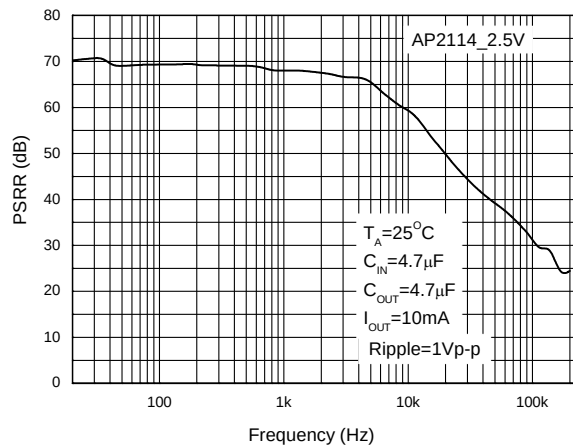
1A LOW NOISE CMOS LDO REGULATOR WITH ENABLE AP2114**Typical Performance Characteristics (Continued)**

Figure 44. PSRR vs. Frequency

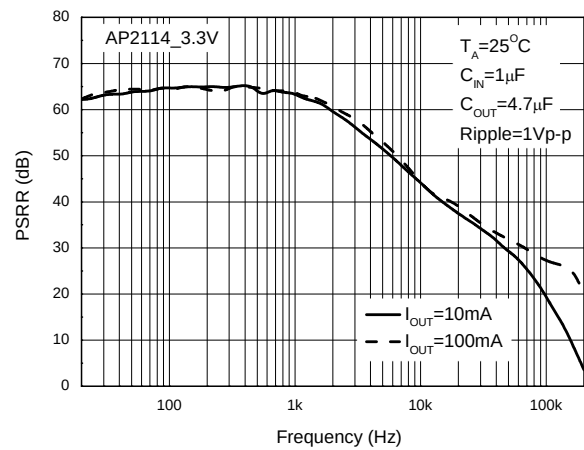


Figure 45. PSRR vs. Frequency

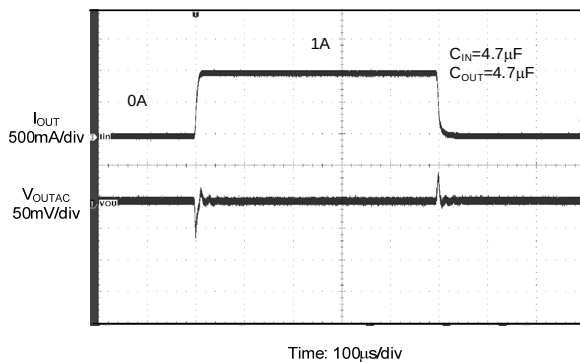


Figure 46. Load Transient

1A LOW NOISE CMOS LDO REGULATOR WITH ENABLE AP2114

Typical Application

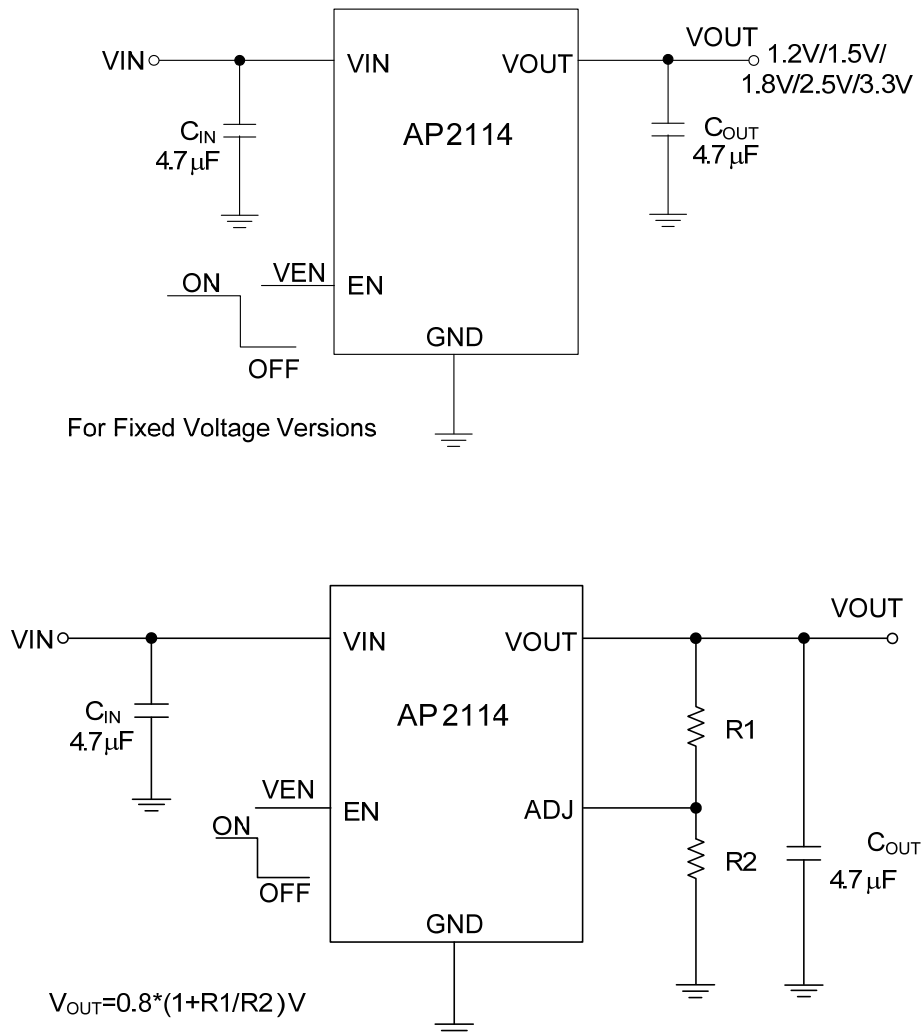


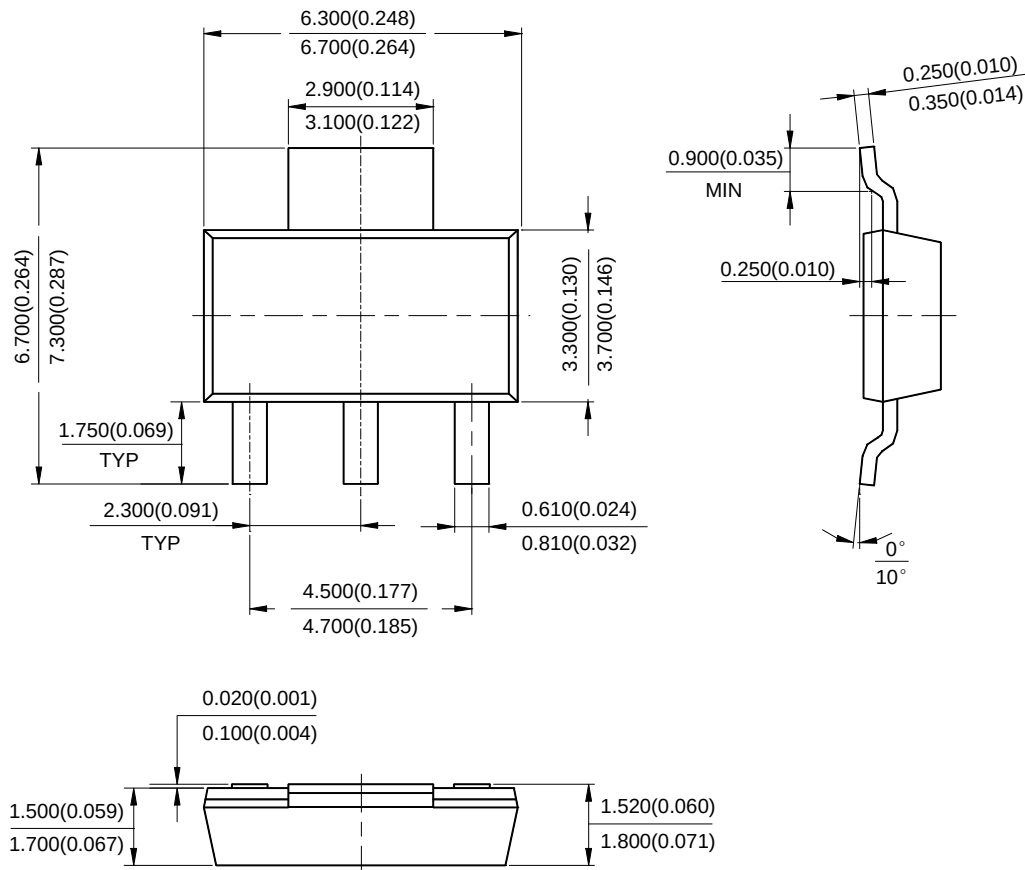
Figure 47. Typical Application of AP2114

1A LOW NOISE CMOS LDO REGULATOR WITH ENABLE AP2114

Mechanical Dimensions

SOT-223

Unit: mm(inch)

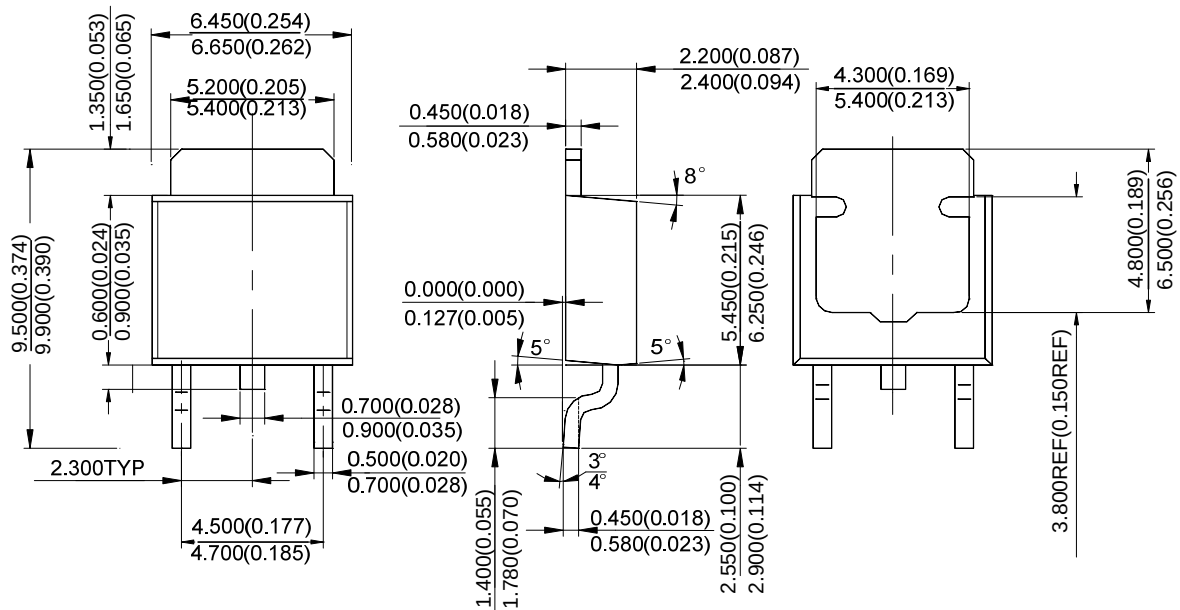


1A LOW NOISE CMOS LDO REGULATOR WITH ENABLE AP2114

Mechanical Dimensions (Continued)

TO-252-2 (1)

Unit: mm(inch)

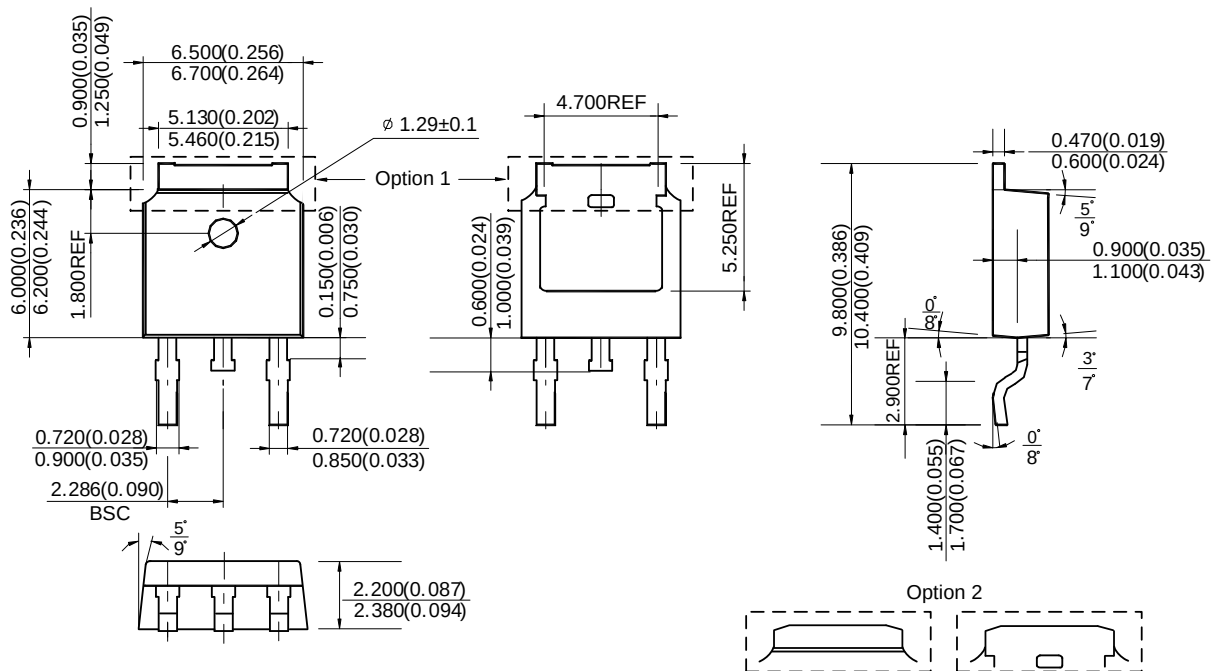


1A LOW NOISE CMOS LDO REGULATOR WITH ENABLE AP2114

Mechanical Dimensions (Continued)

TO-252-2 (3)

Unit: mm(inch)

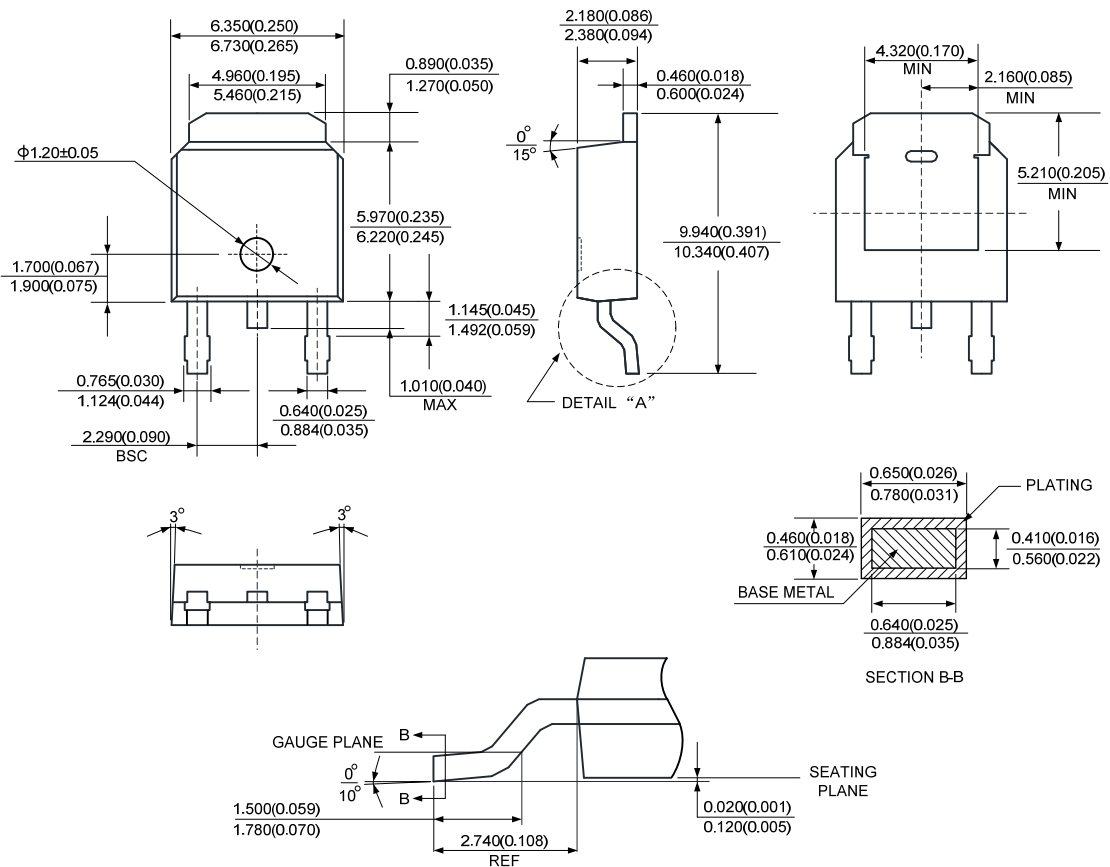


1A LOW NOISE CMOS LDO REGULATOR WITH ENABLE AP2114

Mechanical Dimensions (Continued)

TO-252-2 (4)

Unit: mm(inch)

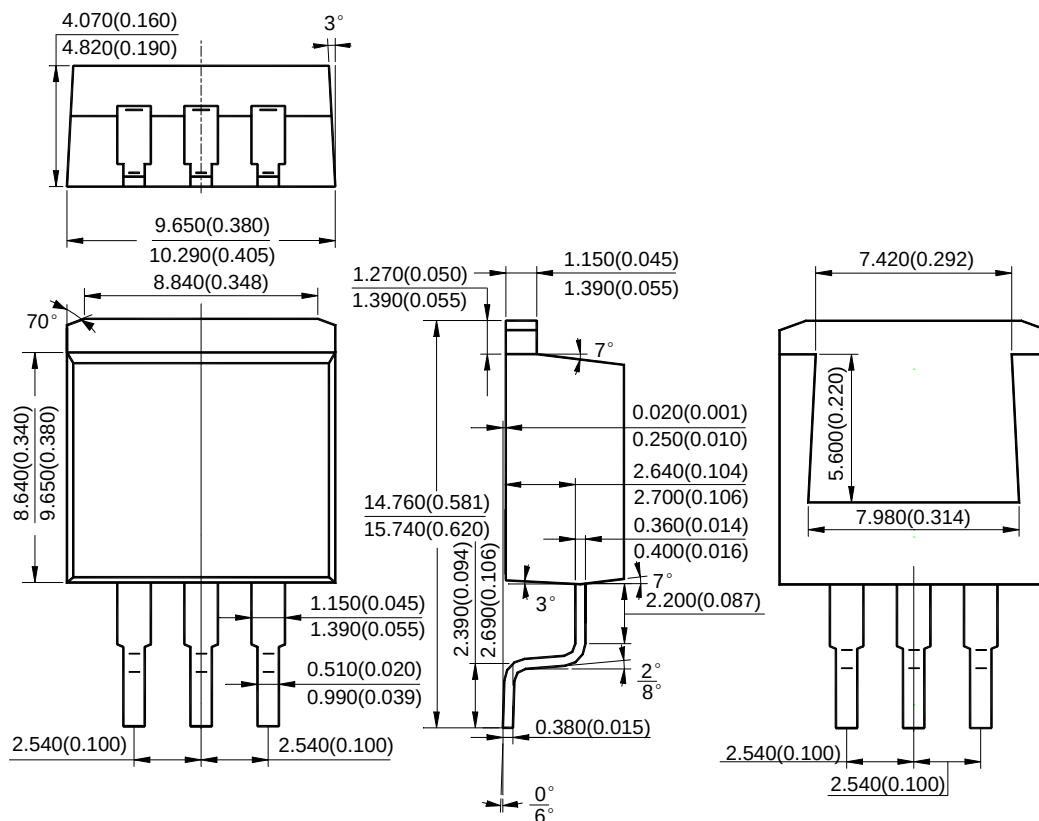


1A LOW NOISE CMOS LDO REGULATOR WITH ENABLE AP2114

Mechanical Dimensions (Continued)

TO-263-3

Unit: mm(inch)

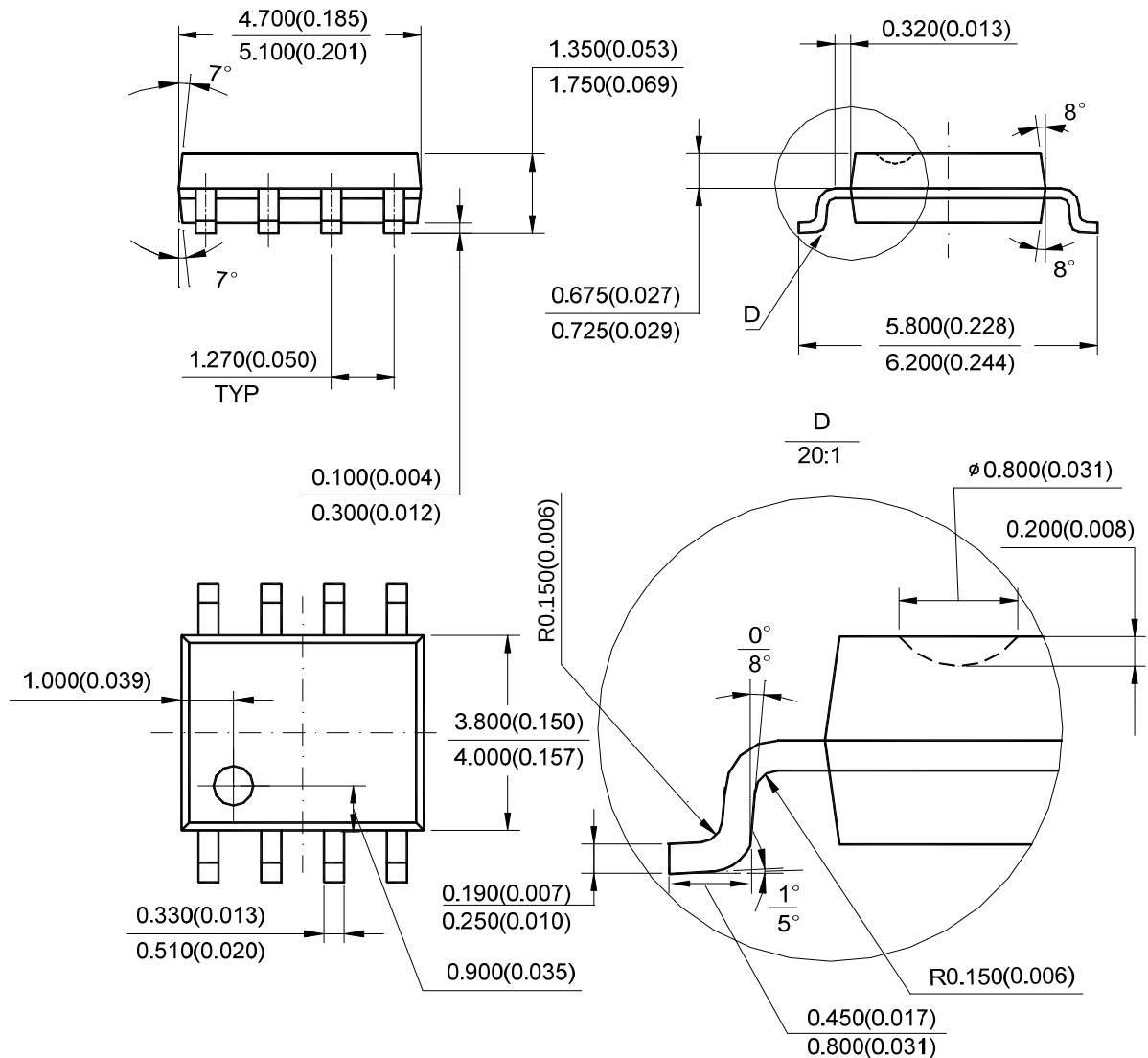


1A LOW NOISE CMOS LDO REGULATOR WITH ENABLE AP2114

Mechanical Dimensions (Continued)

SOIC-8

Unit: mm(inch)



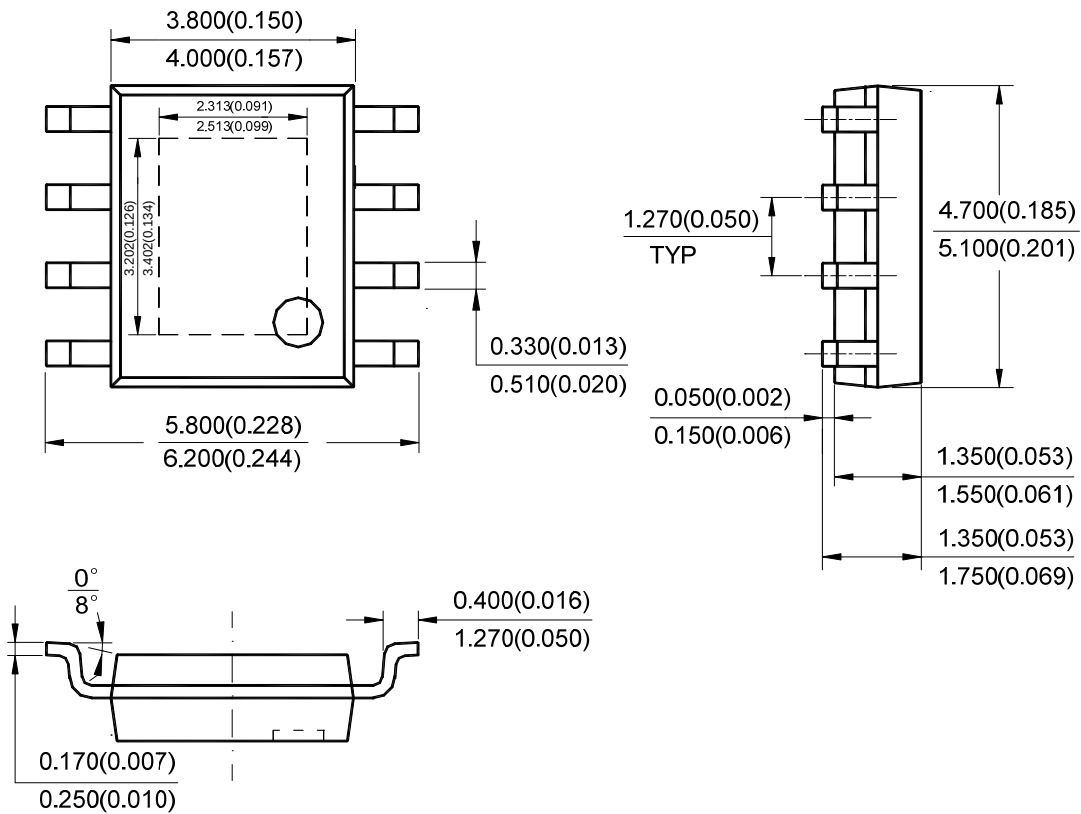
Note: Eject hole, oriented hole and mold mark is optional.

1A LOW NOISE CMOS LDO REGULATOR WITH ENABLE AP2114

Mechanical Dimensions (Continued)

PSOP-8

Unit: mm(inch)



Note: Eject hole, oriented hole and mold mark is optional.



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